

WNSC101200 Silicon Carbide Diode Rev.03 - 04 December 2019

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Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO220-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T_{i(max)} = 175 °C)

3. Applications

- Power factor correction
 - Telecom / Server SMPS
 - UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions			Values		
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage	ak reverse 1200			V		
I _{F(AV)}	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 144 °C; Fig. 1; Fig. 2; Fig. 3; Fig. 4	10		А		
T _j	junction temperature		175		°C		
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>		-	1.4	1.6	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>		-	1.85	2.3	V
		I _F = 10 A; T _j = 175 °C; <u>Fig. 6</u>		-	2	2.6	V
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 10 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 8$		-	24	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	К — Ң — А
2	А	anode	205	001aaa020
mb	к	mounting base; connected to cathode		

6. Ordering information

Table 3. Ordering information								
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WNSC101200	TO220-2L	WNSC101200Q	Tube	50	SOD59A	30-Mar-2015		

7. Marking

Table 4. Marking codes	
Type number	Marking codes
WNSC101200	WNSC101200

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		1200	V
V_{RWM}	crest working reverse voltage		1200	V
V _R	reverse voltage	DC	1200	V
$\boldsymbol{I}_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 144 °C; Fig. 1; Fig. 2; Fig. 3; Fig. 4	10	A
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t _p = 25 µs; T _{mb} ≤ 144 °C; square-wave pulse	20	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	110	А
	forward current	t_p = 10 µs; $T_{j(init)}$ = 25 °C; sine-wave pulse	720	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	61	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C

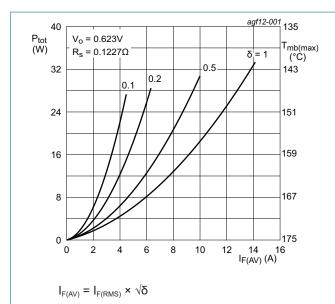
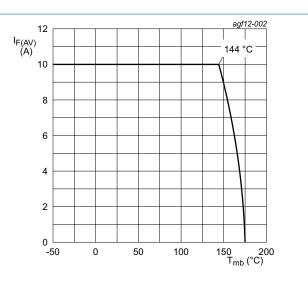
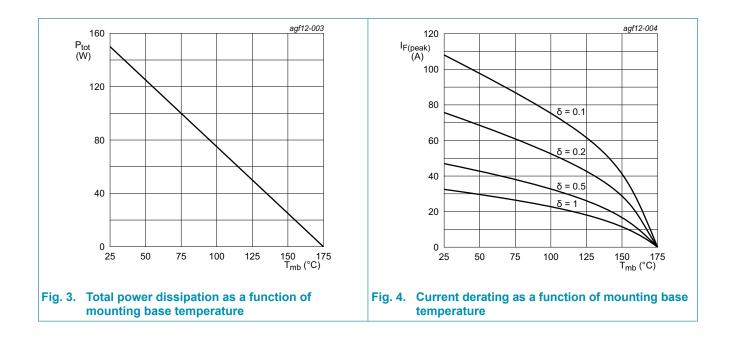


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; typical values

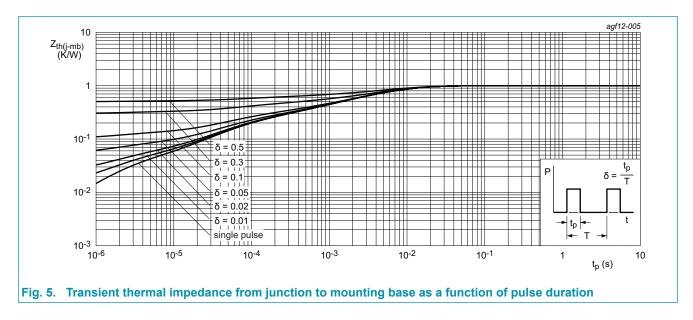






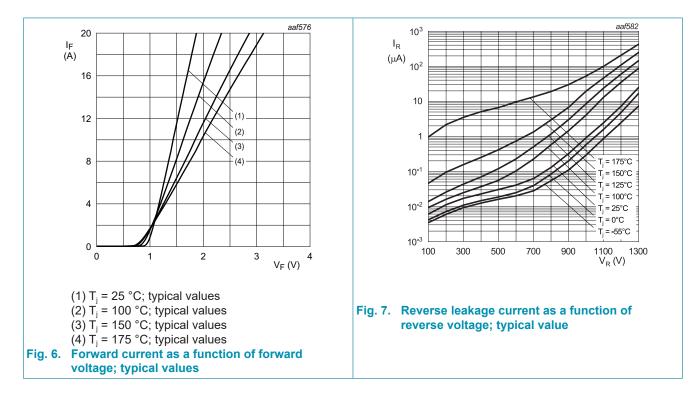
9. Thermal characteristics

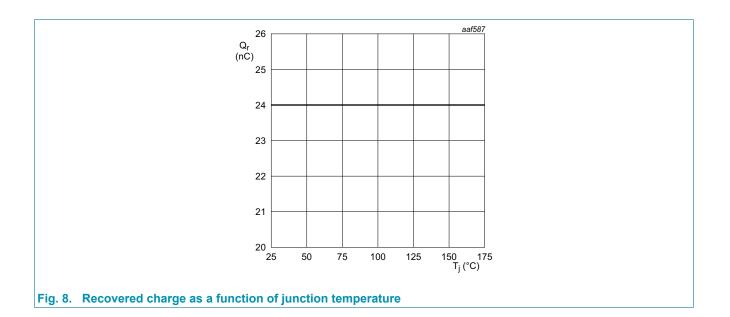
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	<u>Fig. 5</u>	-	-	1	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W



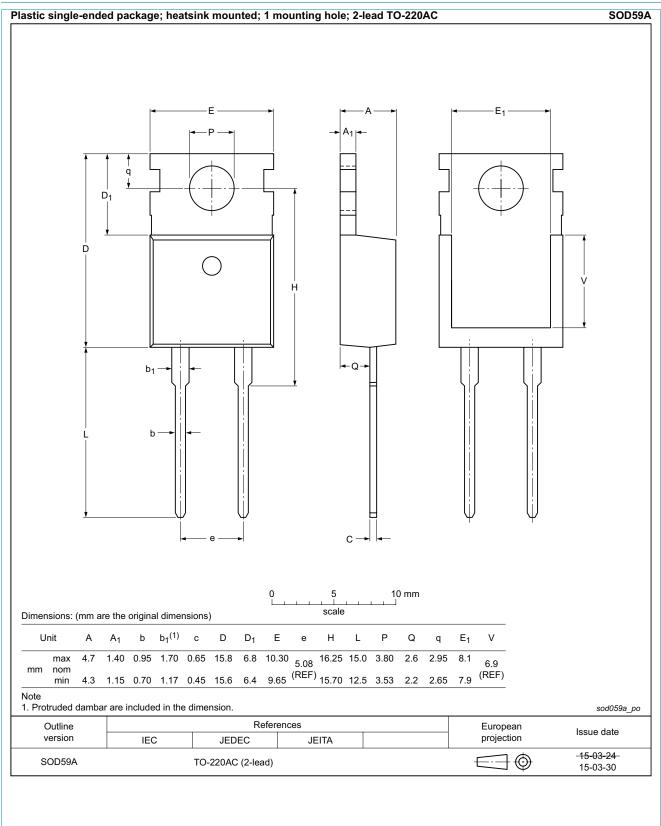
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
$V_{\rm F}$	forward current	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.4	1.6	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>	-	1.85	2.3	V
		I _F = 10 A; T _j = 175 °C; <u>Fig. 6</u>	-	2	2.6	V
I _R	reverse current	V _R = 1200 V; T _j = 25 °C; <u>Fig. 7</u>	-	10	110	μA
		V _R = 1200 V; T _j = 175 °C; <u>Fig. 7</u>	-	450	-	μA
Dynamic	characteristics	· · ·				
Q _r	recovered charge	I _F = 10 A; V _R = 400 V; dI _F /dt = 500 A/μs; T _j = 25 °C; <u>Fig. 8</u>	-	24	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	510	-	pF
		f = 1 MHz; V _R = 400 V; T _j = 25 °C	-	48	-	pF
		f = 1 MHz; V _R = 800 V; T _j = 25 °C	-	41	-	pF





11. Package outline



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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